

Micro Commercial Components Corp.

Complete Discrete Semiconductor Solutions

| package type SOT-23 VRM(PRV) 120V Ifsm 0.5A IF(AV) 200mA @Vf 1.25V @If 200mA Trr 50nS IR 100nA @VR 120V | Part Number | BAS19 | |
|---|----------------|-----------------------------------|--|
| VRM(PRV) 120V Ifsm 0.5A IF(AV) 200mA @Vf 1.25V @If 200mA Trr 50nS IR 100nA @VR 120V | product family | SMALL SIGNAL DIODES | |
| Ifsm 0.5A IF(AV) 200mA @Vf 1.25V @If 200mA Trr 50nS IR 100nA @VR 120V | package type | SOT-23 | |
| IF(AV) 200mA @Vf 1.25V @If 200mA Trr 50nS IR 100nA @VR 120V | VRM(PRV) | 120V | |
| @Vf 1.25V @If 200mA Trr 50nS IR 100nA @VR 120V | Ifsm | 0.5A | |
| @If 200mA Trr 50nS IR 100nA @VR 120V | IF(AV) | 200mA | |
| Trr 50nS IR 100nA @VR 120V | @Vf | 1.25V | |
| IR 100nA @VR 120V | @If | 200mA | |
| @VR 120V | Trr | 50nS | |
| | IR | 100nA | |
| | @VR | 120V | |
| Package Qty Tape: 3K/Reel, 30k/Box, 120K/Ctn; | Package Qty | Tape: 3K/Reel, 30k/Box, 120K/Ctn; | |



BAS19 THRU BAS21

Features

- Ideally Suited for Automatic Insertion
- 150°C Junction Temperature
- Fast Switching speed
- **Epitaxial Planar Die Construction**

Mechanical Data

- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0 and MSL Rating 1
- Weight: 0.008 grams (approx.)

| MCC Part Number | Marking | Continuous Reverse Voltage V _R (V) | Repetitive Peak Reverse Voltage V _{RRM} (V) |
|--------------------|---------|--|--|
| BAS19 | JP | 100 | 120 |
| BAS20 | JR | 150 | 200 |
| BAS21 | JS | 200 | 250 |

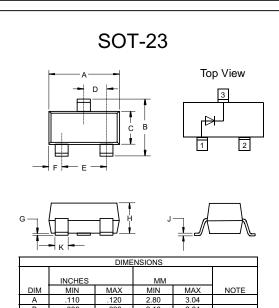
Maximum Ratings @ 25°C Unless Otherwise Specified

| Parameter | Symbol | Value | Unit |
|--|--------------------|--------------------|------|
| Non-repetitive Peak @ t=1us | 1 | 2.5 | ۸ |
| Forward Surge Current @ t=1s | I _{FSM} | 0.5 | Α |
| Average Rectified Forward Current | I _{F(AV)} | 200 ⁽¹⁾ | mΑ |
| Forward DC Current at T _{amb} =25°C | I _F | 200 ⁽²⁾ | mA |
| Repetitive Peak Forward Current | I _{FRM} | 625 | mA |
| Power Dissipation up to T _{amb} =25°C | P _{tot} | 250 | mW |
| Thermal Resistance Junction to Ambient | $R_{	heta JA}$ | 430 | °C/W |
| Operating & Storage Temperature | T_{j}, T_{STG} | -65~150 | °C |

- **Notes:** (1) Measured under pulse conditions;
 - Pulse time = $t_p \le 0.3$ ms
 - (2) Device on fiberglass substrate,

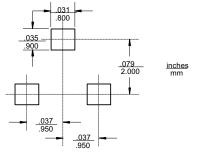
See layout on next page

Small Signal Diodes 250mW



| DIMENSIONS | | | | | |
|------------|--------|-------|------|------|------|
| | INCHES | | MM | | |
| DIM | MIN | MAX | MIN | MAX | NOTE |
| Α | .110 | .120 | 2.80 | 3.04 | |
| В | .083 | .098 | 2.10 | 2.64 | |
| C | .047 | .055 | 1.20 | 1.40 | |
| D | .035 | .041 | .89 | 1.03 | |
| E | .070 | .081 | 1.78 | 2.05 | |
| F | .018 | .024 | .45 | .60 | |
| G | .0005 | .0039 | .013 | .100 | |
| Ι | .035 | .044 | .89 | 1.12 | |
| J | .003 | .007 | .085 | .180 | |
| K | .015 | .020 | .37 | .51 | |

Suggested Solder Pad Layout





BAS19 thru BAS21

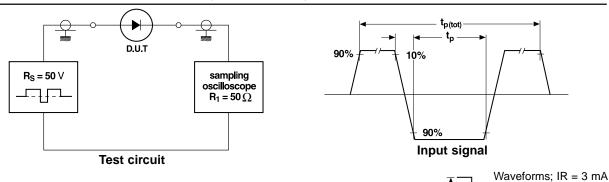
Electrical Characteristics (TJ = 25°C unless otherwise noted)

Micro Commercial Components

| | (.0 =0 0 | | | | | |
|-------------------------------------|-----------------|---|-----|-----|-------------|----------|
| Parameter | Symbol | Test Condition | Min | Тур | Max | Unit |
| Forward Voltage | VF | IF = 100mA IF = 200mA | _ | _ | 1.0 1.25 | V V |
| Leakage Current | I _R | $V_R = V_{Rmax}$ $V_R = V_{Rmax}$; $T_j = 150$ °C | _ | _ | 100 100 | nA μA |
| Dynamic Forward Resistance | rf | IF = 10mA | _ | 5 | _ | Ω |
| Capacitance | Ctot | V _R = 0 f = 1MHz | _ | _ | 5 | pF |
| Reverse Recovery Time (see figures) | t _{rr} | $I_{F} = 30\text{mA}, \ I_{R} = 30\text{mA}$ $I_{rr} = 3\text{mA}, \ R_{L} = 100\Omega$ | _ | _ | 50 | ns |

⁽¹⁾Device on fiberglass substrate, see layout (SOT-23).

Test Circuit and Waveforms (BAS19, BAS20, BAS21)

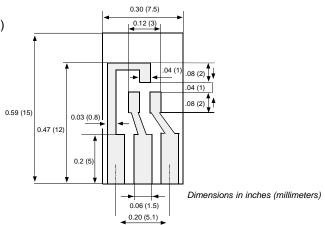


| Input Signal | total pulse durationduty factorrise time of reverse pulsereverse pulse duration | $tp(tot) = 2\mu s$ $\delta = 0.0025$ $t_r = 0.6ns$ $t_p = 100ns$ |
|--------------|--|--|
| Oscilloscope | - rise time - cicuit capitance* | t _r = 0.35ns C < 1pF |

Output signal

Layout for R⊝JA test

Thickness: Fiberglass 0.059 in. (1.5 mm) Copper leads 0.012 in. (0.3 mm)



^{*}C = oscilloscope input capactitance + parasitic capacitance



Ordering Information

| Device | Packing |
|------------------|---------------------|
| (Part Number)-TP | Tape&Reel3Kpcs/Reel |

IMPORTANT NOTICE

Micro Commercial Components Corp. reserves the right to make changes without further notice to any product herein to make corrections, modifications, enhancements, improvements, or other changes.
Micro Commercial Components Corp. does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Micro Commercial Components Corp. and all the companies whose products are represented on our website, harmless against all damages.

APPLICATIONS DISCLAIMER

Products offer by *Micro Commercial Components Corp* . are not intended for use in Medical,

Aerospace or Military Applications.